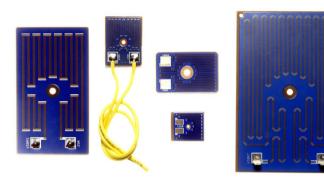
# **Ultra Low Profile Power Resistors**

# **WDBR** Series



#### Features:

- Ultra low profile thick-film on steel
- 500W to 7kW peak power
- Single fixing heatsink mountable
- Ideal for dynamic braking, inrush limit and snubber circuits
- Choice of flying leads, push-on tags or solder terminations
- Low inductance design
- High isolation, even after failsafe overload fusing
- Non-flammable construction



All Pb-free parts comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

#### **Electrical Data**

	WDBR1/2	WDBR1	WDBR2	WDBR3	WDBR5	WDBR7
Ω	2R2 – 150R	3R3 – 270R	8R2 – 820R	8R2 – 1KO	10R – 1K5	10R – 1K0
	E12 preferred. 20R, 25R and 50R are also available.					
%	10					
kW	0.5	1	2	3	5	7
W	160	180	200	260	270	280
W	300	700	780	900	1000	1490
ppm/°C	<+600					
°C	450					
°C	-55 to +200					
V (dc/ac pk)	2500					
μH	<3			<4	<5	<6
	% kW W ppm/°C °C °C V (dc/ac pk)	Ω  2R2 – 150R    2R2 – 150R    2R2 – 150R    %	Ω  2R2 – 150R  3R3 – 270R    2R2 – 150R  3R3 – 270R    E12 prefer    %    KW  0.5    160  180    W  300    700    ppm/°C    °C    V (dc/ac pk)	Ω  2R2 – 150R  3R3 – 270R  8R2 – 820R    2R2 – 150R  3R3 – 270R  8R2 – 820R    E12 preferred. 20R, 25R and 20R  11  12    %  0.5  1  2    %  0.5  1  2    %  160  180  200    %  300  700  780    ppm/°C	Ω  2R2 – 150R  3R3 – 270R  8R2 – 820R  8R2 – 1K0     E12 preferred. 20R, 25R and 50R are als    %   50R are als    %   1  2    kW  0.5  1  2    160  180  200  260    W  300  700  780  900    ppm/°C        °C    -55 to +200    V (dc/ac pk)	N  2R2 – 150R  3R3 – 270R  8R2 – 820R  8R2 – 1K0  10R – 1K5    M  C  E12 preferred. 20R, 25R are also available.  300  50    M  0.5  1  2  3  5    M  160  180  200  260  270    M  300  700  780  900  1000    ppm/°C

Notes

For details of pulse condition see Fig. 1 in Performance Data.
 Nounted on a 0.53°C/W heatsink with no forced air cooling, air temperature 25°C.
 Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C.

4. Based on 100% production test, duration 2s minimum.

## **Physical Data**

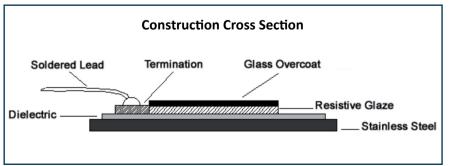
Dimensio	ns in mm	and we	ight w	ithout t	erminat	tions in	g			╷─┻┨С┞╋╾ ────────────────────────────────────
Туре	<b>L</b> ±0.1	<b>W</b> ±0.1	<b>t</b> ±0.1	ØD nom	<b>a</b> nom	<b>b</b> nom	<b>c</b> nom	<b>d</b> min	Wt. nom	t = substrate
WDBR1/2	31.9	28.1		2.2	7.5	3.1	4.3	1.4	6.5	thickness.
WDBR1	49.3	35.9		3.2	3.2	11.2	6.2	1.9	12.6	d = clearance
WDBR2	61	40.6	0.9		4.7	13	5.8	3.8	17.1	between exposed conductor and
WDBR3	101.6	70		5.3	13.5	22	10.2	7.2	50.8	exposed steel substrate.
WDBR5	122	70		5.3	14	23.8	7.4	6.1	60.7	
WDBR7	152.4	101.6	1.5		15	51.3	9.2	7.9	181.8	L

Notes:

ores: 1. The fixing hole is located centrally except on WDBR1/2 where the dimension from the edge by the terminations to the mounting hole centre is 16.7mm. 2. In addition to the central fixing hole, WDBR7 has two smaller corner holes. These are present for manufacturing purposes only and should not be used as fixing holes.

#### Construction

A high integrity dielectric layer is applied to a machined stainless-steel substrate. Thickfilm conductor and resistor patterns are printed and fired, then protected with a high temperature overglaze. The termination pads are tinned with solder and optional terminals or leads are soldered on.



General Note

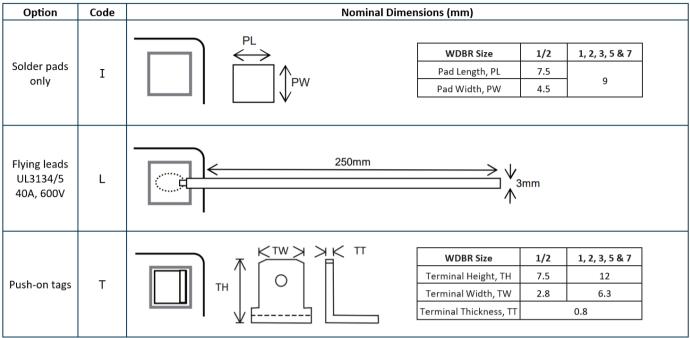
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# **Ultra Low Profile Power Resistors**



## **WDBR Series**

# **Termination Options**

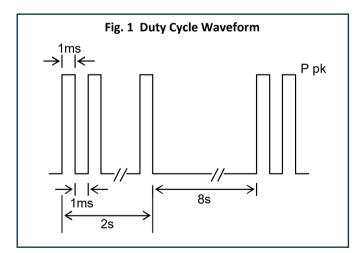


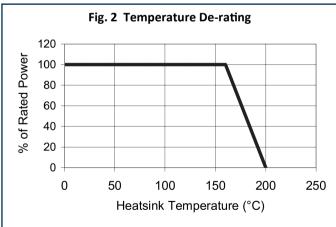
Note:

Note: Two options exist for solder type. The standard is SnAg (96SC) which is Pb-free and the second (HT) is high temperature HMP alloy which is Pb-bearing. Both are RoHS compliant, but the second relies on the RoHS exemption for high temperature solders and is targeted at specialist high temperature applications.

### **Performance Data**

	±ΔR%
Pulsed load at full pulse power rating 50,000 cycles (see Fig. 1) Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C	5
Derating at heatsink temperatures >160°C	See Fig. 2





General Note

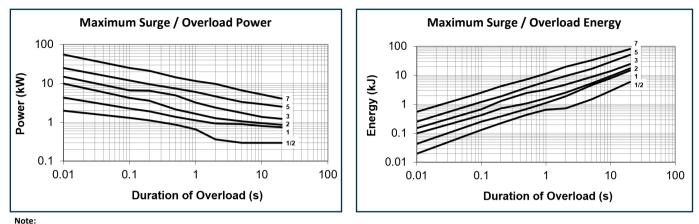
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# **Ultra Low Profile Power Resistors**



# **WDBR Series**

### **Pulse and Overload Performance**



Mounted on a 0.53°C/W heatsink with 5m/s forced air cooling, air temperature 25°C. Single pulse or low repetition rate, such that mean power ≤ 10% of rated power.  $\Delta R \le 5\%$ 

#### Maximum Peak Current

Туре	Maximum Peak Current (A)
WDBR1/2	≤15R: 15.2 >15R: 7.6
WDBR1	≤20R: 21.6 >20R: 8.3
WDBR2	≤15R: 20.3 >15R: 7.6
WDBR3	≤22R: 25.4 >22R: 11.4
WDBR5	≤25R: 25.4 >25R: 10.2
WDBR7	≤25R: 44.5 >25R: 20.3

### **Application Notes**

A heatsink with thermal resistance  $\leq 0.53^{\circ}$ C/W will enable the component to operate at its continuous power rating. Sufficient thermal grease (e.g. Dow Corning DC340) to give void-free coverage, or a 0.5mm thick compliant thermal pad (e.g. T Global TG-X) should be used and the heatsink should have a surface finish of  $< 6.3 \mu$ m with flatness of < 0.05mm. The resistor should be mounted using an appropriate bolt as listed in the table below. This should be tightened so as to bring the whole area of the steel substrate into intimate contact with the heatsink. The unmounted part is slightly bowed so that the centre is above the edges. Inadequate tightening will leave the centre out of contact with the heatsink, whilst over tightening can cause the edges to rise. The tightening torque required will depend on the fixings and heatsink used, but typical figures are given for guidance.

Туре	Bolt Size	Typical Tightening Torque (Nm)			
WDBR1/2	M2	0.6			
WDBR1	M3	2			
WDBR2		2.5			
WDBR3	M5	2.3			
WDBR5	CIVIS	3.5			
WDBR7		4			

WDBR resistors will fail safe (open circuit) under overload fault conditions and still maintain a 1kV dielectric withstand.

Soldering of solder pad (termination I) variants requires the use of a hot plate. Hand solder process recommendations are available.

WDBR resistors may be customised in various ways including:

- Alternative shapes and dimensions up to 406mm x 406mm
- Integration of temperature measurement elements and thermal cutouts
- Alternative ohmic values and tolerances
- Increased dielectric withstand voltage
- Custom braking resistors
- Integration of multiple power resistors

For a similar product with UL508 recognition see WDBR-UL: https://www.ttelectronics.com/TTElectronics/media/ProductFiles/Datasheet/WDBR-UL.pdf

General Note

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# **WDBR Series**

# **Ordering Procedure**

Example: WDBR2-100RKLW (WDBR2 with standard solder and flying lead terminations, 100 ohms ±10%, Pb-free)



1	2	3	4	5	6				
Туре	Solder Option	Value	Tolerance	Termination	Packing				
WDBR1/2	Omit for standard	E12	K = ±10%	I = Solder	W = Stan	dard bulk pa	ck at quantit	ies below	
WDBR1	(96SC)	3/4 characters		pads only	Туре	Term. I	Term. L	Term. T	
WDBR2	HT = High	R = ohms		L = Flying	WDBR1/2	180/box		64/box	
WDBR3	Temperature	K = kilohms		leads	WDBR1	100/box	40/box	80/box	
WDBR5				T = Push-on	WDBR2	100/00X		80/D0X	
WDBR7				tags	WDBR3	40/box		40/box	
					WDBR5	40/00X	20/box	40/00X	
					WDBR7		-		